

AN7316

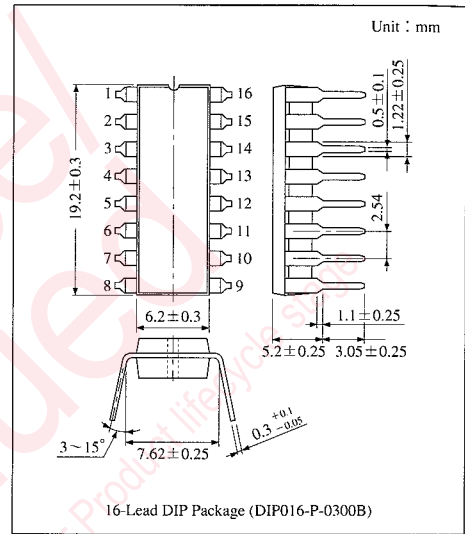
Dual Recording/Playback Pre-Amplifier IC for Cassette

Overview

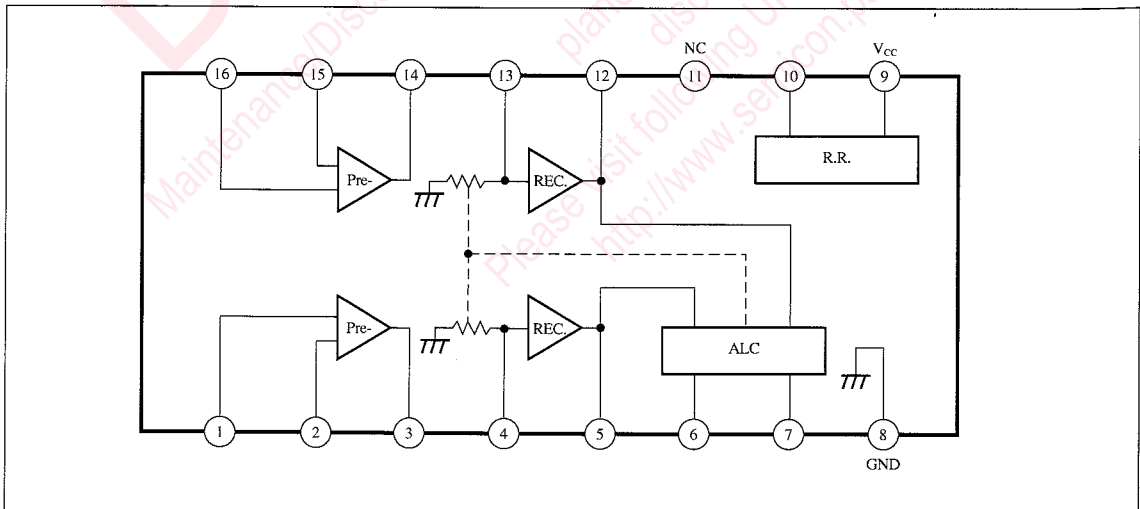
The AN7316 is an integrated circuit for radio cassette recorder and built-in only fundamental function of rec./playback pre-amp. with ALC function in 2-channel 16-pin · DIL plastic package.

Features

- Built-in ALC LOW CUT function
- Rec. amp gain fixed and external parts reduced
- Wide operating supply voltage range (4V ~ 12V)



Block Diagram



Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit
Supply Voltage	V _{CC}	14	V
Supply Current	I _{CC}	30	mA
Power Dissipation	P _D	1,000	mW
Operating Ambient Temperature	T _{opr}	-20 ~ +75	°C
Storage Temperature	T _{stg}	-55 ~ +150	°C

Recommended Operating Range (Ta=25°C)

Parameter	Symbol	Range
Operating Supply Voltage Range	V _{CC}	3.5V ~ 12V

Electrical Characteristics (V_{CC}=6V, f=1kHz, Ta=25°C)

Parameter	Symbol	Condition	min.	typ.	max.	Unit
No Signal Current Consumption	I _{tot}		8.8	11.4	15.3	mA

<Playback Amp.>

Open Circuit Gain	G _{VO-p}	R _{NF}	75	84	—	dB
Closed Circuit Gain	G _{VC-p}	NAB	40	43	46	dB
Max. Output Voltage	V _{om-p}	THD=3%	1.4	1.7	—	V
Total Harmonic Distortion	THD _{-p}	400Hz~80kHz	—	0.038	0.1	%
Noise Voltage Referred to Input	V _{ni-p}	R _{in} =2.2kΩ, DIN/AUDIO	—	1.1	2	μV
Crosstalk between Channels	CT _{-p}	R _{in} =2.2kΩ, DIN/AUDIO	64	71.5	—	dB
Channel Balance	CB _{-p}		-1.5	0	1.5	dB

<Rec. Amp>

Closed Circuit Gain	G _{v-r}		37	39	42.5	dB
Max. Output Voltage	V _{om-r}	THD=3%	1	1.9	—	V
Total Harmonic Distortion	THD _{-r}	400Hz~80kHz	—	0.1	0.17	%
Output Noise Voltage	V _{no-r}	R _{in} =3kΩ, DIN/AUDIO	—	260	550	μV
Crosstalk between Channels	CT _{-r}	R _{in} =3kΩ, DIN/AUDIO	50	51	—	dB
Channel Balance	CB _{-r}		-1.5	0	1.5	dB

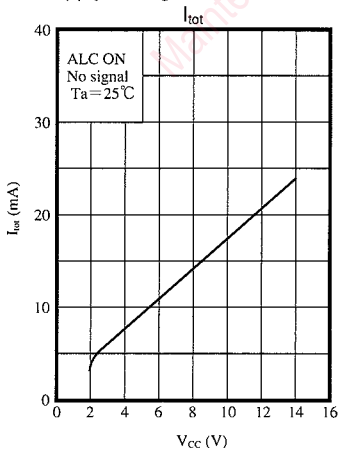
<ALC>

ALC Start Voltage	V _S	R _{in} =5.6kΩ, Dual Ch. input	0.75	0.9	1.37	V
ALC Effective Width	W _{ALC}	R _{in} =5.6kΩ, Dual Ch. input	35	46	—	dB
ALC Channel Balance	CB _{-a}	R _{in} =5.6kΩ, Dual Ch. input	-2	0.1	2	dB

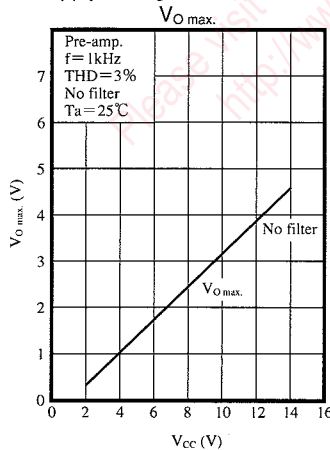
ICs for
Cassette
Deck

Characteristics Curve

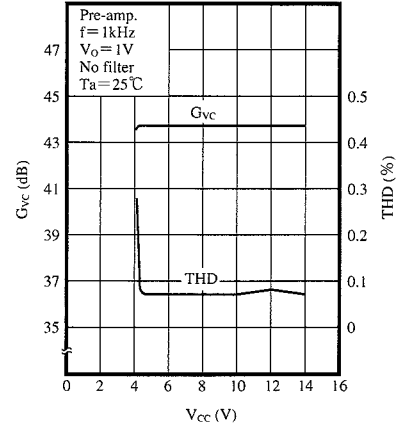
Supply Voltage Characteristics—



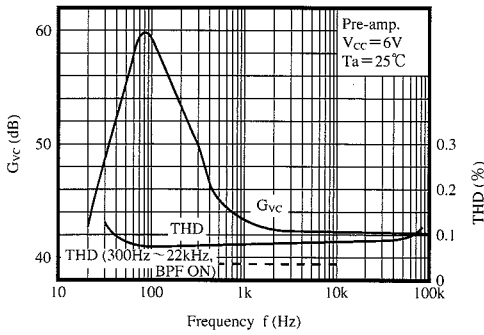
Supply Voltage Characteristics—



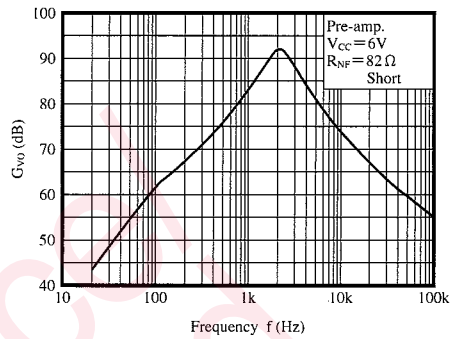
Supply Voltage Characteristics—



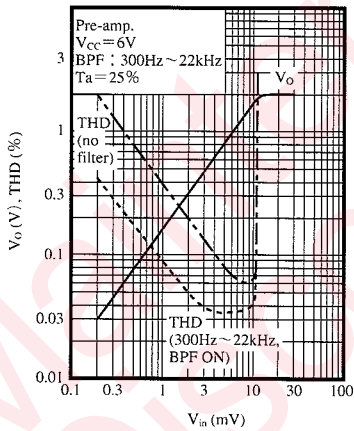
Frequency Characteristics— G_{VC} , THD (NAB)



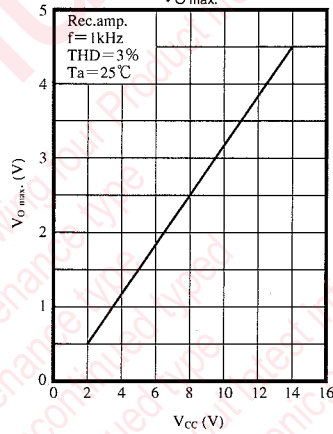
Frequency Characteristics— G_{VO}



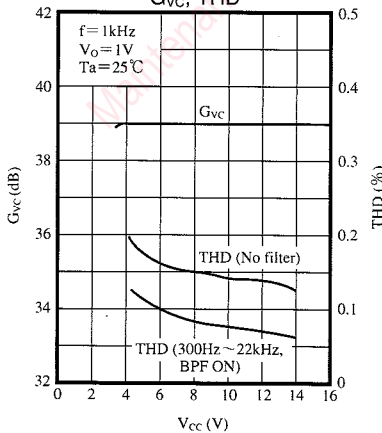
Input/Output, Distortion Characteristics



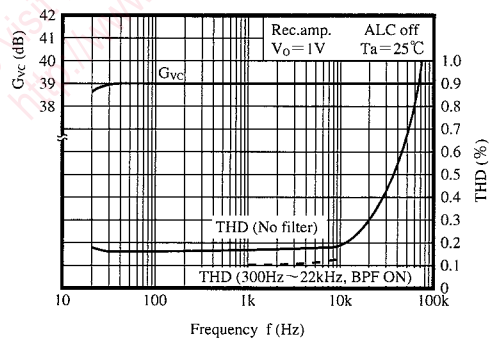
Supply Voltage Characteristics— $V_{O \max}$



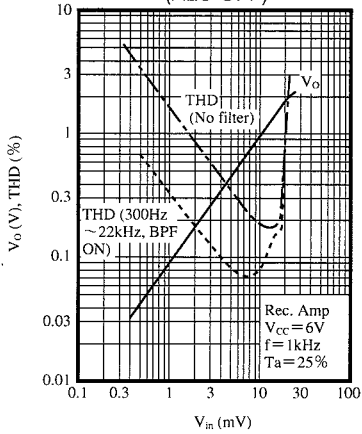
Supply Voltage Characteristics— G_{VC} , THD



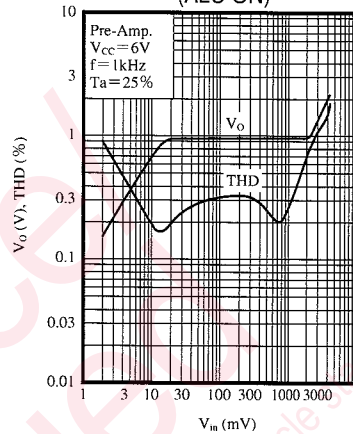
Frequency Characteristics— G_{VC} , THD



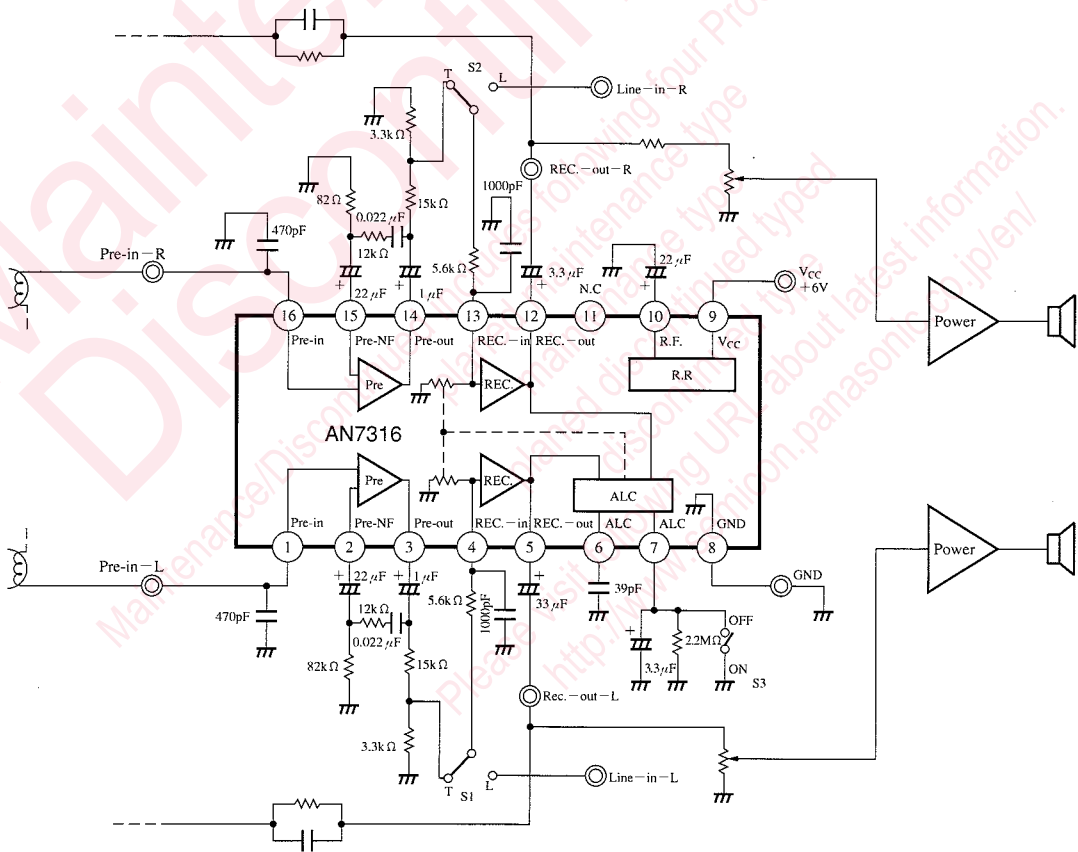
Input/Output, Distortion Characteristics (ALC OFF)



Input/Output, Distortion Characteristics (ALC ON)


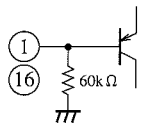
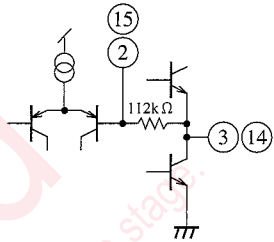



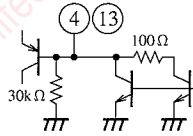

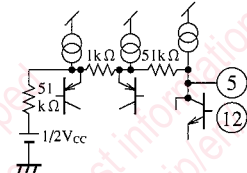
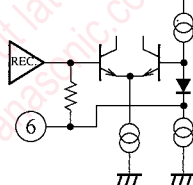
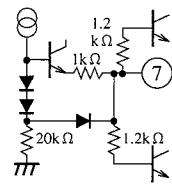
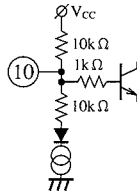


Application Circuit



ICs for Cassette Deck

Pin Descriptions

Pin No.	Pin Name	Typ. Waveform	Description	Equivalent Circuit
1	Ch.1 Playback Amp. Input	 -43.6dBV	Playback amp. input	
16	Ch.2 Playback Amp. Input			
2	Ch.1 Playback Amp. Negative Feedback	DC 0.7V	Playback amp. feedback	
15	Ch.2 Playback Amp. Negative Feedback			
3	Ch.1 Playback Amp. Output	 0dBV	Playback amp. output	
14	Ch.2 Playback Amp. Output			
4	Ch.1 Rec. Amp. Input	 -39dBV	Rec. amp. input	
13	Ch.2 Rec. Amp. Input			
5	Ch.1 Rec. Amp. Output	 0dBV	Rec. amp. output	
12	Ch.2 Rec. Amp. Output			
6	Low CUT	DC about 2.5V	AGC comparator circuit reference voltage	
7	ALC Time Constant	Follow input signal	Low-pass filter pin	
8	GND	—	Main circuit GND	—
9	V _{cc}	DC 6V	Main circuit +V _{cc}	—
10	V _{ref}	DC 3.7V		
11	NC	—		—

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